Product data sheet

1. Product profile

1.1 General description

The BB153 is a variable capacitance diode, fabricated in planar technology and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features and benefits

- Excellent linearity
- Excellent matching to 2 % DMA
- Very small SMD plastic package
- $C_{d(28V)}$: 2.6 pF; $C_{d(1V)}$ to $C_{d(28V)}$ ratio: 15
- Very low series resistance.

1.3 Applications

- Electronic tuning in VHF television tuners, band B up to 460 MHz
- Voltage Controlled Oscillators (VCO).

2. Pinning information

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								. 3

Pin	Description	Simplified outline[1]	Symbol
1	cathode		JI.
2	anode	1 2	sym008

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB153	SC-76	plastic surface mounted package; 2 leads	SOD323



VHF variable capacitance diode

4. Marking

Table 3. Marking

Type number	Marking code
BB153	PC

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	32	V
V_{RM}	peak reverse voltage	in series with a 10 $k\Omega$ resistor	-	35	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
T _j	junction temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_R	reverse current	see Figure 2				
		V _R = 30 V	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r _s	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$	-	0.65	8.0	Ω
C _d diode		f = 1 MHz; see Figure 1 and 3				
	capacitance	V _R = 1 V	34.65	-	42.35	pF
		V _R = 28 V	2.361	2.6	2.754	pF
$\frac{C_{d(1V)}}{C_{d(2V)}}$	capacitance ratio	f = 1 MHz	-	1.3	-	
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	13.5	15	-	
$\frac{C_{d(25V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	-	1.08	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1 \text{ V to } 28 \text{ V; in a}$ sequence of 10 diodes (gliding)	-	-	2	%

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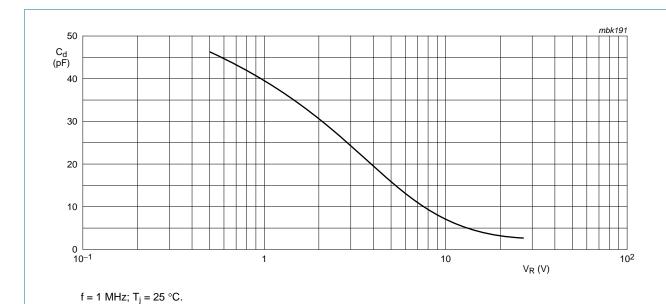


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

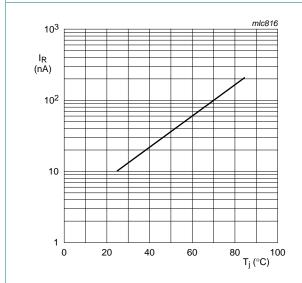
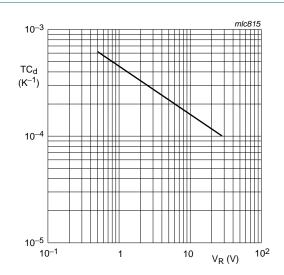


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_j = 0$ °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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7. Package outline

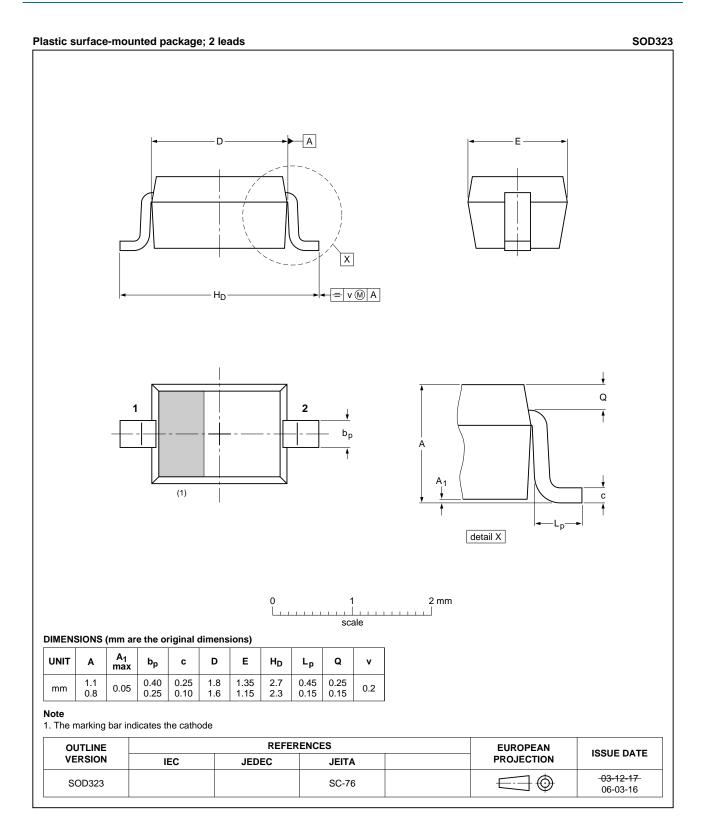


Fig 4. Package outline SOD323 (SC-76).

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8. Revision history

Table 6. Revision history

Release date	Data sheet status	Change notice	Supersedes
20110906	Product data sheet	-	BB153 v.3
guidelines of	NXP Semiconductors.		,
•	•	• •	• • •
20041005	Product data sheet	-	BB153 v.2
20040225	Product specification	-	BB153 v.1
19971217	Product specification	-	-
	20110906 The format of guidelines of Legal texts he Package out 20041005	 20110906 Product data sheet The format of this data sheet has been redeguidelines of NXP Semiconductors. Legal texts have been adapted to the new of Package outline drawings have been updated 20041005 Product data sheet 20040225 Product specification 	 Product data sheet

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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